

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Customer Number: 20277

Doug Van Den BROEKE, et al.

et No.: 55071-283

Confirmation Number: 4766

Serial No.: 10/659,715

Group Art Unit: 2878

Filed: September 11, 2003

Examiner:

METHOD OF ACHIEVING CD LINEARITY CONTROL FOR FULL-CHIP CPL

MANUFACTURING

INFORMATION DISCLOSURE STATEMENT

Mail Stop IDS Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-1449. It is respectfully requested that the documents be expressly considered during the prosecution of this application, and that the documents be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

10/659,715

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

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Date: May 17, 2004

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APPLICATION (DTO 1440)					APPLICANT Doug Van Den BROEKE, et al.						
(PTO-1449)					FILING DATE GROU						
YEN					September 11, 2003 2878						
TOTHAD				U.S. PATENT	DOCUMENTS						
EXAMINER'S INITIALS	CITE NO.	Numb	Document Number per-Kind Code2 (# known)	Publication Date MM- DD-YYYY	Name of Patentee or Applicant of Cited Document			Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear			
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EVALUAÇÃO		1.		S. S. State (1985)	, Title, Date, Pertinent Pages, Etc.)	4b = 14 (b + +4) -					
EXAMINER'S INITIALS	CITE NO.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.									
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1 Applicant's unique citation designation number (optional). 2 Applicant is to place a check mark here if English language Translation is attached.